

## Highlights

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### Hysteresis in the transfer characteristics of MoS<sub>2</sub> transistors

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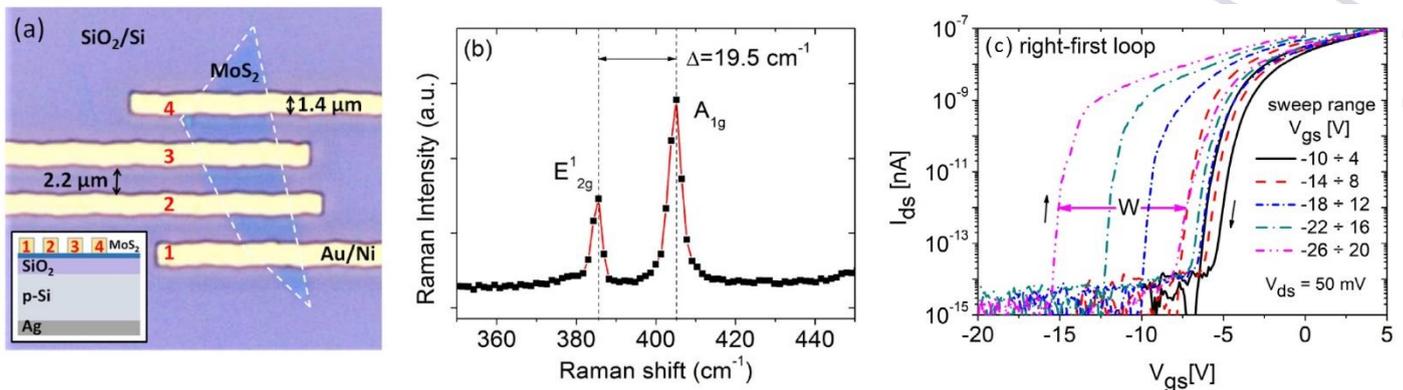
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Molybdenum disulfide (MoS<sub>2</sub>) has recently become one of the most popular semiconductors from the family of the transition metal dichalcogenides. The MoS<sub>2</sub> bandgap can be controlled by the number of layers: Bulk MoS<sub>2</sub> has an indirect bandgap of 1.2 eV while monolayer MoS<sub>2</sub> has a direct bandgap of 1.8 eV. The large bandgap, combined with mechanical flexibility, makes MoS<sub>2</sub> suitable as channel in field effect transistors (FETs) for logic applications.

We investigate the origin of the hysteresis observed in the transfer characteristics of back-gated field effect transistors with an exfoliated MoS<sub>2</sub> channel. We find that the hysteresis is strongly enhanced by increasing either gate voltage, pressure, temperature or light intensity. Our measurements reveal a step-like behavior of the hysteresis around room temperature, which we explain as water-facilitated charge trapping at the MoS<sub>2</sub>/SiO<sub>2</sub> interface. We conclude that intrinsic defects in MoS<sub>2</sub>, such as S vacancies, which result in effective positive charge trapping, play an important role, besides H<sub>2</sub>O and O<sub>2</sub> adsorbates on the unpassivated device surface. We show that the bistability associated to the hysteresis can be exploited in memory devices.



**Figure 1.** (a) Optical image of a monolayer MoS<sub>2</sub> flake (highlighted by dashed white lines) contacted with Ni/Au leads; the inset shows the schematic cross-section of the back-gated FET. (b) Raman spectrum of the MoS<sub>2</sub> flake. (c) Transfer characteristics of the MoS<sub>2</sub> transistor for the back-gate voltage,  $V_{gs}$ , in loops of different amplitudes but with fixed steps ( $V_{gs} = 0.1$  V).